15

INV2 □

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16

LH2

#### Independent Dual-Outputs Operate 180° **DBT PACKAGE** (TOP VIEW) **Out of Phase** Wide Input Voltage Range: 4.5-V - 28-V INV1 □ 30 \_\_\_\_ LH1 Adjustable Output Voltage Down to 0.9 V FB1 29 $\square$ OUT1\_u SOFTSTART1 28 \_\_\_\_ LL1 Pin-Selectable PWM/SKIP Mode for High PWM/SKIP 27 OUT1\_d П **Efficiency Under Light Loads** CT □ 26 OUTGND1 Synchronous Buck Operation Allows up to 5V\_STBY □ 25 TRIP1 6 95% Efficiency GND 24 $\square$ $\vee_{CC}$ **Separate Standby Control and Overcurrent** 23 □□ TRIP2 REF □□ **Protection for Each Channel** STBY1 \_\_\_ 9 22 STBY2 □□ 10 21 □□ REG5V IN **Programmable Short-Circuit Protection** 11 20 FLT $\square$ OUTGND2 Low Supply (1 mA) and Shutdown (1 nA) 12 19 POWERGOOD oxdot OUT2 d Current 13 18 SOFTSTART2 oxdot LL2 **Power Good Output** 14 17 oxdot OUT2 u FB2 □

### description

Circuitry

**High-Speed Error Amplifiers** 

**Softstart Capacitor Values.** 

30-Pin TSSOP Packaging

Sequencing Easily Achieved by Selecting

5-V Linear Regulator Power Internal IC

The TPS5120 is a dual channel, high-efficiency synchronous buck controller where the outputs run 180 degrees out of phase, which lowers the input current ripple, thereby reducing the input capacitance cost. The PWM/SKIP pin allows the operating mode to switch from PWM mode to skip mode under light load conditions. The skip mode enables a lower operating frequency and shortens the pulse width to the low-side MOSFET, increasing the efficiency under light load conditions. These two modes, along with synchronous-rectifier drivers, dead time, and very low quiescent current, allow power to be conserved and the battery life to be extended under all load conditions. The 1.5 A (typical) high-side and low-side MOSFET drivers on-chip are designed to drive less expensive N-channel MOSFETs. The resistorless current protection and fixed high-side driver voltage simplify the power supply design and reduce the external parts count. Each channel is independent, offering a separate controller, overcurrent protection, and standby control. Sequencing is flexible and can be tailored by choosing different softstart capacitor values. Other features, such as undervoltage lockout, power good, overvoltage, undervoltage, and programmable short-circuit protection promote system reliability.



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### typical design

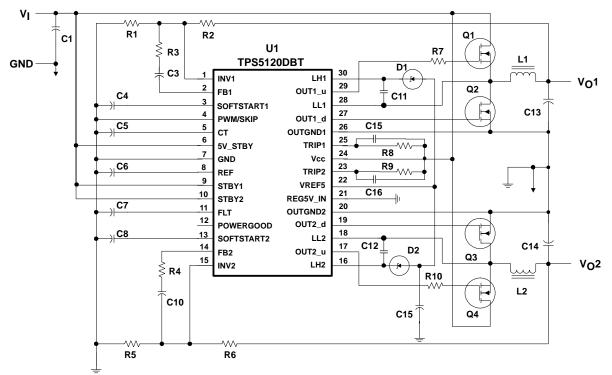
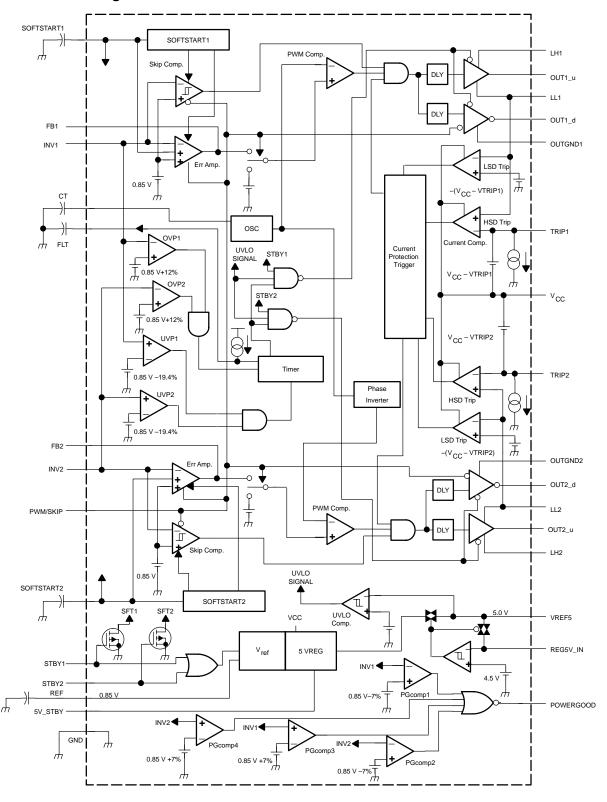


Figure 1. EVM Typical Design



### functional block diagram





### **AVAILABLE OPTIONS**

	PACKAGE	
TA	TSSOP (DBT)	EVM
4000 1- 0500	TPS5120DBT	TPS5120EVM-151
–40°C to 85°C	TPS5120DBTR	

### **Terminal Functions**

TERMINAL			
NAME	NO.	1/0	DESCRIPTION
СТ	5	I/O	External capacitor from CT to GND for adjusting the triangle oscillator
FB1	2	0	Feedback output of CH1 error amplifier
FB2	14	0	Feedback output of CH2 error amplifier
GND	7		Control GND
INV1	1	I	Inverting input of the CH1 error amplifier, skip comparator, and OVP1/UVP1 comparator
INV2	15	I	Inverting input of the CH2 error amplifier, skip comparator, and OVP2/UVP2 comparator
LH1	30	I/O	Bootstrap capacitor connection for CH1 high-side gate drive
LH2	16	I/O	Bootstrap capacitor connection for CH2 high-side gate drive
LL1	28	I/O	Bootstrap this pin low for CH1 high-side gate driving return and output current protection. Connect this pin to the junction of the high-side and low-side FETs for a floating drive configuration.
LL2	18	I/O	Bootstrap this pin low for CH2 high-side gate driving return and output current protection. Connect this pin to the junction of the high-side and low-side FETs for a floating drive configuration.
OUT1_d	27	0	Gate drive output for CH1 low-side gate drive
OUT2_d	19	0	Gate drive output for CH2 low-side gate drive
OUT1_u	29	0	Gate drive output for CH1 high-side switching FETs
OUT2_u	17	0	Gate drive output for CH2 high-side switching FETs
OUTGND1	26		Ground for CH1 FET drivers
OUTGND2	20		Ground for CH2 FET drivers
POWERGOOD	12	0	Power good open-drain output. When low, POWERGOOD reports an output fail condition. PG comparators monitor both SMPS's over voltage and UVLO of VREF5. The threshold is $\pm 7\%$ . When the SMPS starts up, the POWERGOOD pin's output goes high. POWERGOOD also monitors VREF5's UVLO output.
PWM/SKIP	4	I	PWM/SKIP mode select pin. The PWM/SKIP pin is used to change the output's operating mode. If this terminal is lower than 0.5 V, it works in PWM mode. When a minimum voltage of 2 V is applied, the device operates in skip mode. In light load condition (< 0.2 A), the skip mode gives a short pulse to the low-side FETs instead of a full pulse. With this control, switching frequency is lowered and switching loss is reduced. Also, the output capacitor energy discharging through the output inductor and low-side FETs is stopped. Therefore, TPS5120 achieves a higher efficiency in light load conditions.
REF	8	0	0.85-V reference voltage output. The 0.85-V reference voltage is used for setting the output voltage and the voltage protection. This reference voltage is dropped down from a 5-V regulator.
REG5V_IN	21	I	External 5-V input
FLT	11	I/O	Fault latch timer pin. An external capacitor is connected between FLT and GND to set the FLT enable time up.
SOFTSTART1	3	I/O	External capacitor from SOFTSTART1 to GND for CH1 softstart control. Separate soft-start terminals make it possible to set the start-up time of each output independently.
SOFTSTART2	13	I/O	External capacitor from SOFTSTART2 to GND for CH2 softstart control. Separate soft-start terminals make it possible to set the start-up time of each output independently.
STBY1	9	I	Standby control for CH1. SMPS1 can be switched into standby mode separately by grounding the STBY1 pin.
STBY2	10	I	Standby control for CH2. SMPS2 can be switched into standby mode separately by grounding the STBY2 pin.
TRIP1	25	ı	External resistor connection for CH1 output current control



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### **Terminal Functions (Continued)**

TERMINA	AL		DECORPORA		
NAME	NO.	10	DESCRIPTION		
TRIP2	23	I	External resistor connection for CH2 output current control		
VCC	24		Supply voltage input		
VREF5	22	0	5-V internal regulator output		
5V_STBY	6	I	5-V linear regulator control		

### detailed description

### switching-mode power supply (SMPS) 1, 2

TPS5120 includes dual SMPS controllers that operate 180° out of phase and at the same frequency. Both channels have standby and softstart.

### 5-V regulator

An internal linear voltage regulator is used for the high-side driver bootstrap voltage and source of VREF (0.85 V). When the 5-V regulator is disconnected from the MOSFET drivers, it is only used for the source of VREF. Since the input voltage range is from 4.5 V to 28 V, this feature offers a fixed voltage for the bootstrap voltage so that the drive design is much easier. It is also used for powering the low-side driver. The tolerance is 4%. The 5-V regulator is disabled when STBY1, STBY2, and 5V\_STBY are all set low.

### 5-V switch

If the internal 5-V switch senses the 5-V input from the REG5V\_IN pin, the internal 5-V linear regulator is disconnected from the MOSFET drivers. The external 5 V is then used for both the low-side driver and the high-side bootstrap, thus, increasing the efficiency.

### error amplifier

Each channel has its own error amplifier to regulate the output voltage of the synchronous buck converter. It is used in the PWM mode for the high output current condition (> 0.2 A). The unity gain bandwidth is 2.5 MHz. This decreases the amplifier delay during fast load transients and contributes to a fast transient response.

### skip comparator

In skip mode, each channel has its own hysteretic comparator to regulate the output voltage of the synchronous buck converter. The hysteresis is set internally and is typically set at 9 mV. The delay from the comparator input to the driver output is typically  $1.2 \, \mu s$ .

### low-side driver

The low-side driver is designed to drive low  $r_{ds(on)}$  N-channel MOSFETs. The maximum drive voltage is 5 V from VREF5. The current rating of the driver is typically 1.5 A at source and sink.

### high-side driver

The high-side driver is designed to drive low  $r_{ds(on)}$  N-channel MOSFETs. The current rating of the driver is 1.2 A at source and sink. When configured as a floating driver, the bias voltage to the driver is developed from VREF5, limiting the maximum drive voltage between OUTx\_u and LLx to 5 V. The maximum voltage that can be applied between LHx and OUTGND is 33 V.

#### deadtime

Deadtime prevents shoot through current from flowing through the main power FETs during switching transitions by actively controlling the turnon time of the MOSFETs drivers.



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### detailed description (continued)

### current protection

Overcurrent protection is achieved by comparing the drain-to-source voltage of the high-side and low-side MOSFET devices to a set-point voltage. This voltage is set using an external resistor between  $V_{CC}$  and the TRIP1 or TRIP2 terminals. If the drain-to-source voltage up exceeds the set-point voltage during high-side conduction, the current limit circuit terminates the high-side driver pulse. If the set-point voltage is exceeded during low-side conduction, the low-side pulse is extended through the next cycle. Together this action has the effect of decreasing the output voltage until the undervoltage protection circuit is activated and the fault latch is set and both the high and low-side MOSFET drivers are shut off.

#### overvoltage protection

For overvoltage protection (OVP), the TPS5120 monitors INV pin voltage. When the INV voltage is higher than 0.95 V (+12%), the OVP comparator output goes high and the FLT timer starts to charge an external capacitor connected to FLT. After a set time, the FLT circuit latches the MOSFET drivers off.

### undervoltage protection

For undervoltage protection (UVP), the TPS5120 monitors INV pin voltage. When the INV voltage is lower than 0.68 V (–19.4%), the OVP comparator output goes high, and the FLT timer starts to charge an external capacitor connected to FLT. Also, when the current comparator triggers the OCP, the UVP comparator detects the under voltage output and starts the FLT capacitor charge. After a set time, the FLT circuit latches off all of the MOSFET drivers.

#### **FLT**

When an OVP or UVP comparator output goes high, the FLT circuit starts to charge the FLT capacitor. If the FLT pin voltage goes beyond a constant level, the TPS5120 latches the MOSFET drivers. At this time, the state of MOSFET is different depending on the OVP alert and the UVP alert. Also, the enable time used to latch the MOSFET driver is decided by the capacity of the FLT capacitor. The charging constant current value is also different depending on whether it is an OVP alert or a UVP alert. The difference is shown in the following equation:

FLT source current (OVP) = FLT source current (UVP)  $\times$  5

#### shutdown

The TPS5120 can be shut down by grounding STBY1, STBY2, and 5V\_STBY. The shutdown current is as low as 1 μA.

### **UVLO**

When the input voltage goes up to about 4 V, the TPS5120 is operational. When the input voltage is lower than the turnon value, the device is turned off. The typical hysteresis voltage is 40 mV.

#### phase Inverter

Phase inverter controls the phase of SMPS1 and SMPS 2. SMPS1 operates in phase with the OSC. SMPS2 operates 180° out of phase from SMPS1. This allows smaller input capacitors to be used.

### oscillator

TPS5120 has a triangle oscillator generator internal to the IC. The oscillation frequency is set by the size of the capacitor connected to the CT pin. The voltage amplitude is  $0.43 \text{ V} \sim 1.17 \text{ V}$ .

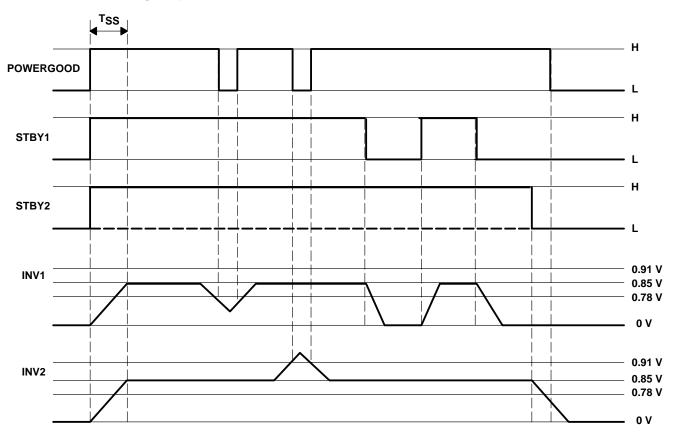


Table 1. Logic Chart

5V_STBY	STBY1	STBY2	SMPS1	SMPS2	5 V REGULATOR	POWERGOOD
L	L	L	Disable	Disable	Disable	Disable
L	L	Н	Disable	Enable	Enable	Active <sup>†</sup>
L	Н	L	Enable	Disable	Enable	Active <sup>†</sup>
L	Н	Н	Enable	Enable	Enable	Active
Н	L	L	Disable	Disable	Enable	L
Н	L	Н	Disable	Enable	Enable	Active <sup>†</sup>
Н	Н	L	Enable	Disable	Enable	Active†
Н	Н	Н	Enable	Enable	Enable	Active

<sup>†</sup>PG is set high during a softstart.

### **POWERGOOD** timing sequence



During a softstart, this channel's powergood comparator output is fixed low (POWERGOOD output is high).

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### absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to the network ground terminal unless otherwise noted.
  - 2. This rating is specified at duty = 10% on output rise and fall each pulse. Each pulse width (rise and fall) for the peak current should not exceed 2 μs.
  - 3. See Dissipation Rating Table for free-air temperature range above 25°C.

### **DISSIPATION RATING TABLE**

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	POWER DISSIPATION T <sub>A</sub> = 85°C
DBT	874 mW	6.993 mW/°C	454 mW

### recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.5		28	V
	INV1, INV2, CT, PWM/SKIP, SOFTSTART1, SOFTSTART2, FLT			6	
Input voltage, V <sub>I</sub>	REG5V_IN, POWERGOOD	-0.1		5.5	
	STBY1, STBY2, 5V_STBY			28	V
	OUT1_u, OUT2_u, LH1, LH2			33	
	TRIP1, TRIP2	-0.1		28	
Oscillator frequency, for	SC		300	500	kHz
Operating free-air temp	erating free-air temperature range, T <sub>A</sub> –40 88		85	°C	



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## electrical characteristics over recommended free-air temperature range, $V_{CC} = 7 \text{ V}$ (unless otherwise noted)

### reference voltage

PARAMETER		TEST COND	MIN	TYP	MAX	UNIT	
V <sub>ref</sub>	Reference voltage				0.85		V
		$T_A = 25^{\circ}C$ ,	Ι = 50 μΑ	-1%		1%	
V <sub>ref(tol)</sub>	Reference voltage tolerance	$T_A = -20^{\circ}C \text{ to } 85^{\circ}C,$	Ι = 50 μΑ	-1.5%		1.5%	
. ,		$T_A = -40^{\circ}C \text{ to } 85^{\circ}C,$	Ι = 50 μΑ	-2%		2%	
R <sub>(egin)</sub>	Line regulation	$V_{CC} = 4.5 \text{ V to } 28 \text{ V},$	Ι = 50 μΑ		0.05	3	mV
R <sub>(egl)</sub>	Load regulation	$I = 0.1 \mu A$ to 1 mA			0.15	5	mV

### oscillator

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
fosc	Frequency	PWM mode, $CT = 44 \text{ pF}$ , $T_A = 25 ^{\circ}\text{C}$		300		kHz
Vон	High level output voltage	DC	1	1.1	1.2	.,
		f <sub>OSC</sub> = 300 kHz		1.17		V
,,	Low level output voltage	DC	0.4	0.5	0.6	.,
VOL		f <sub>OSC</sub> = 300 kHz		0.43		V

### error amplifier

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
VIO	Input offset voltage	T <sub>A</sub> = 25°C		2	10	mV
	Open-loop voltage gain		50			dB
	Unity-gain bandwidth			2.5		MHz
I <sub>(snk)</sub>	Output sink current	V <sub>O</sub> = 1 V	0.3	0.7		mA
I <sub>(src)</sub>	Output source current	V <sub>O</sub> = 1 V	0.2	0.9		mA

### skip comparator

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>hys</sub>	Hysteresis window	SKIP mode		9		mV

### duty control

	PARAMETER	TEST CO	MIN	TYP	MAX	UNIT	
DUTY	Maximum duty cycle	300 kHz,	$V_I = 0 V$		83%		

### control

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Ţ,		STBY1, STBY2	2.2			.,
VIH	High-level input voltage	PWM/SKIP, 5V_STBY	2.2			V
, , , , , , , , , , , , , , , , , , ,	I ow-level input voltage	STBY1, STBY2			0.3	
$V_{IL}$		PWM/SKIP, 5V_STBY			0.3	V

### 5-V internal switch

PARAMETER	TEST CONDITIONS	MIN	TYP MAX	UNIT
V <sub>(TO_H)</sub>		4.2	4.8	.,
V(TO_L) Threshold		4.1	4.7	V
V <sub>hys</sub> Hysteresis		30	200	mV



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## electrical characteristics over recommended free-air temperature range, $V_{CC}$ = 7 V (unless otherwise noted) (continued)

### 5-V regulator

	PARAMETER	TEST CON	IDITIONS	MIN	TYP	MAX	UNIT
VO	Output voltage	$I_O = 0$ mA to 50 mA, $T_A = 25$ °C	$V_{CC} = 5.5 \text{ V to } 28 \text{ V},$	4.8		5.2	V
R <sub>(egin)</sub>	Line regulation	$V_{CC} = 5.5 \text{ V to } 28 \text{ V},$	I =10 mA			20	mV
R <sub>(egl)</sub>	Load regulation	I = 1 mA to 10 mA,	V <sub>CC</sub> = 5.5 V			40	mV
los	Short circuit output current	5VREG = 0 V,	T <sub>A</sub> = 25°C	65			mA
V(TO_H)	LIVI O throughold voltage	EV OUT voltage		3.6		4.2	V
V(TO_L)	UVLO threshold voltage	5V_OUT voltage		3.5		4.1	V
V <sub>hys</sub>	Hysteresis	5V_OUT voltage		30		150	mV

### output drivers

•						
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	OUT_u sink current	V <sub>O</sub> = 3 V		1.2		Α
	OUT_u source current	V <sub>O</sub> = 2 V		-1.5		Α
	OUT_d sink current	V <sub>O</sub> = 3 V	1.5			Α
	OUT_d source current	V <sub>O</sub> = 2 V	-1.5		Α	
I(TRIP)	TRIP pin current	T <sub>A</sub> = 25°C	11.5	13	14.5	μΑ

### soft start

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I(SOFT)	Soft start current		1.6	2.3	2.9	μΑ
V(TO_H)	Throphold voltage (SVID mode)			3.7		.,
V(TO_L)	Threshold voltage (SKIP mode)			2.5		V

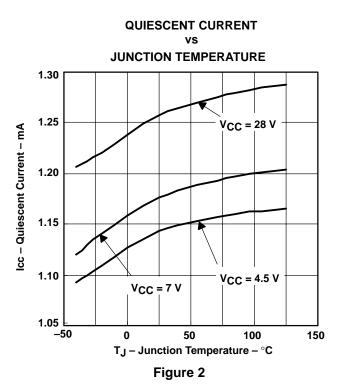
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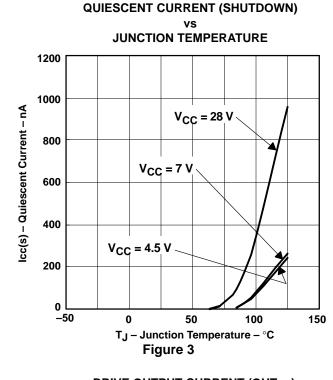
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OVP comparator threshold		0.91	0.95	0.99	V
UVP comparator threshold		0.64	0.68	0.72	V
PG comparator 1, 2 threshold		0.75	0.78	0.81	V
PG comparator 3, 4 threshold		0.88	0.91	0.94	V
DO COLLA CONTROLOGO	Turnon	13 1.2			
PG propagation delay from INV to POWERGOOD	Turnoff				μs
	UVP protection	1.5	2.3	3.1	
Timer latch current source	OVP protection	8	11.5	15	μΑ

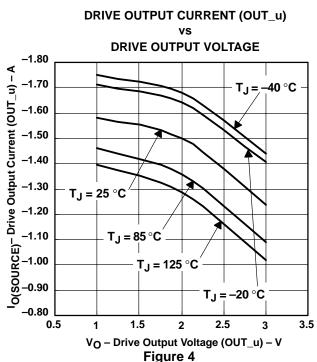
### supply current

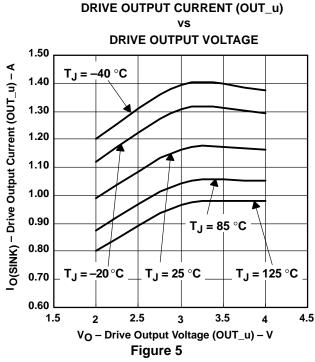
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Icc	Supply current	$T_A = 25^{\circ}C$ , $CT = 0 \text{ V}$ , $INV = 0 \text{ V}$		1.1	1.5	mA
ICC(S)	Shutdown current	STBY 1, STBY2, 5V_STBY = 0 V		0.001	10	μΑ

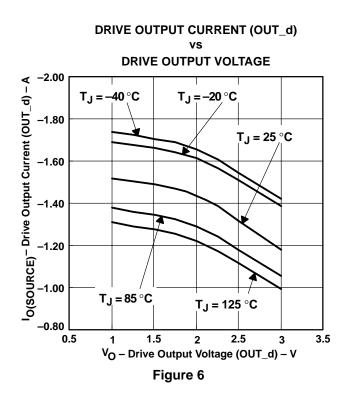


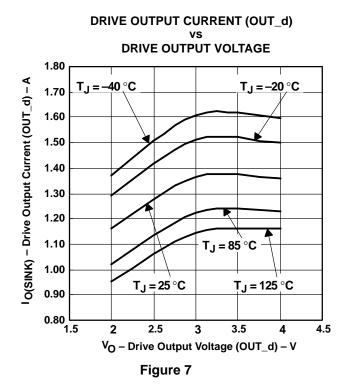


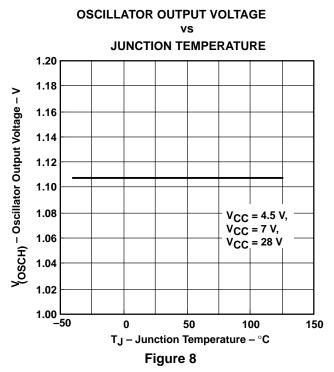


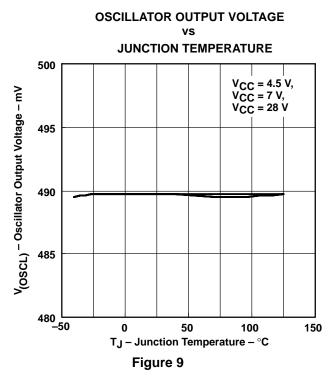




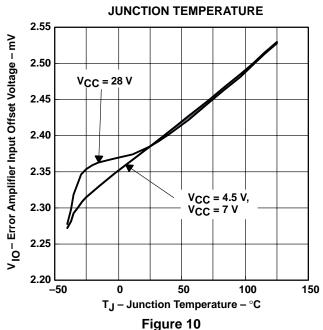




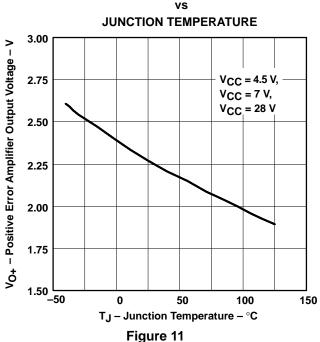




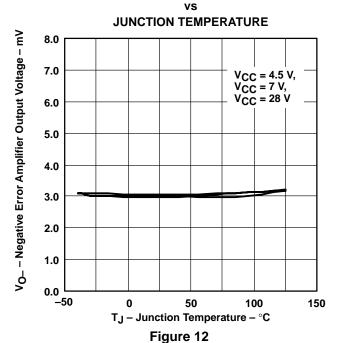
# ERROR AMPLIFIER INPUT OFFSET VOLTAGE vs JUNCTION TEMPERATURE



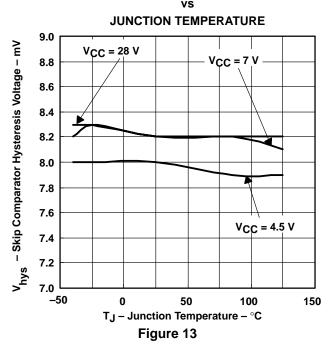
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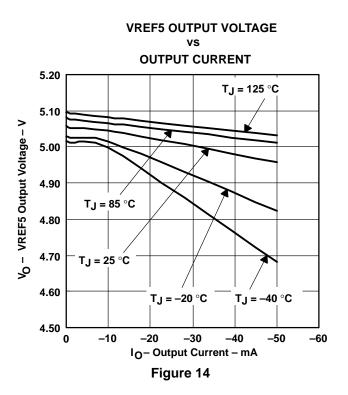


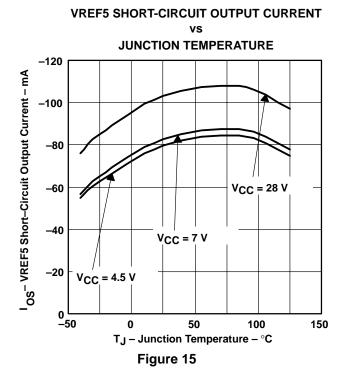
### **ERROR AMPLIFIER OUTPUT VOLTAGE**

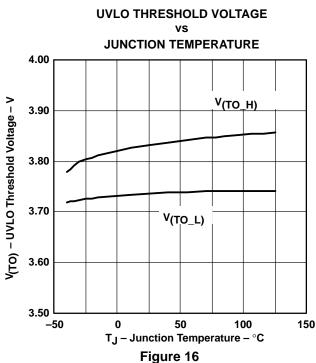


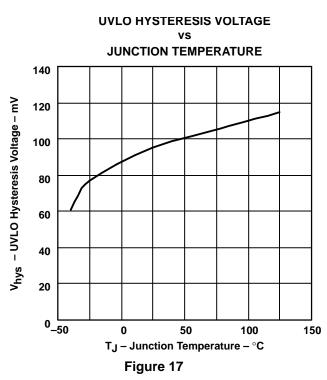
### SKIP COMPARATOR HYSTERESIS VOLTAGE

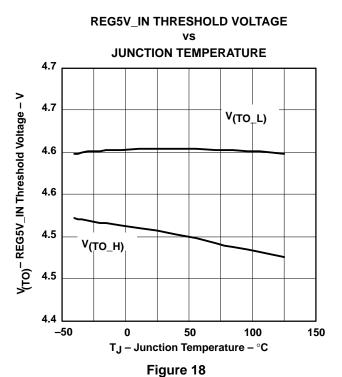




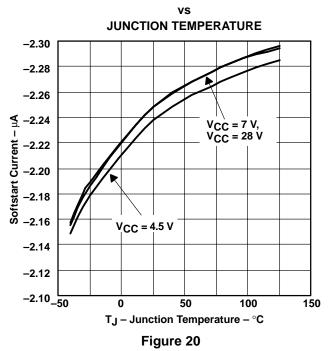








SOFTSTART CURRENT



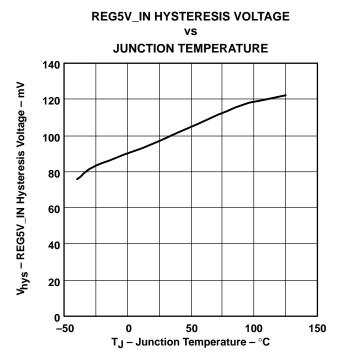
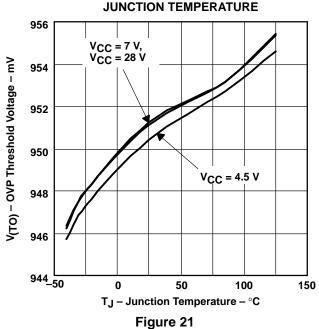


Figure 19

OVP THRESHOLD VOLTAGE

VS



### **POWERGOOD THRESHOLD VOLTAGE JUNCTION TEMPERATURE** 950 V(TO) - Powergood Threshold Voltage - mV 925 V(TO\_H) 900 $V_{CC} = 4.5 V,$ $V_{CC} = 7 V$ $V_{CC} = 28 V$ 875 850 825 $V_{CC} = 4.5 V$ $V_{CC} = 7 V$ 800 $V_{CC} = 28 \text{ V}$ 775 V(TO\_L) 750 <u>–</u>50 50 100 150 T<sub>J</sub> - Junction Temperature - °C Figure 22



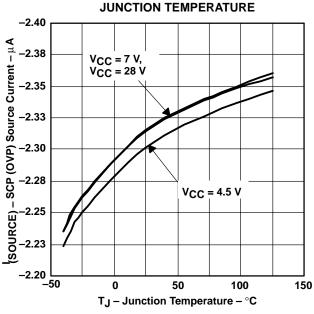
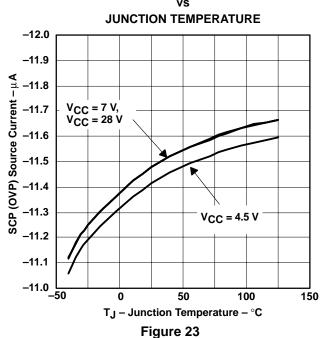


Figure 24

### SCP (OVP) SOURCE CURRENT



### TRIP SINK CURRENT

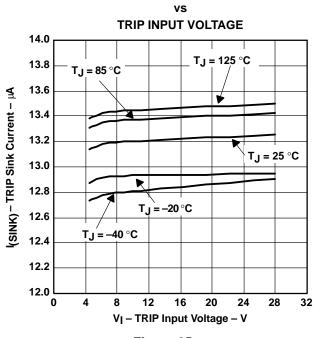
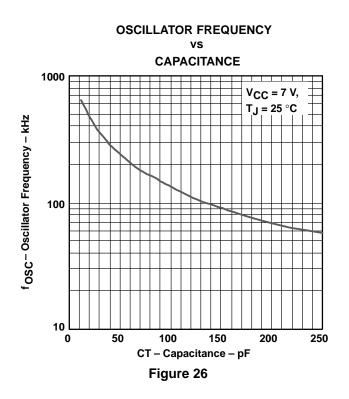
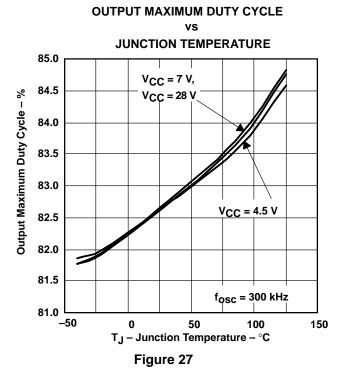
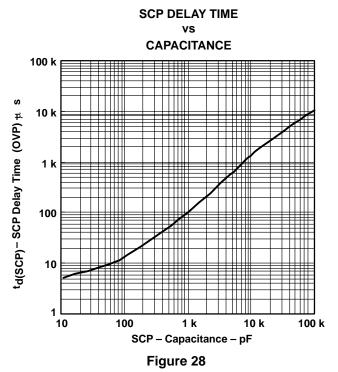
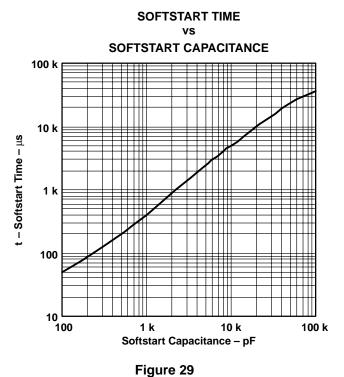


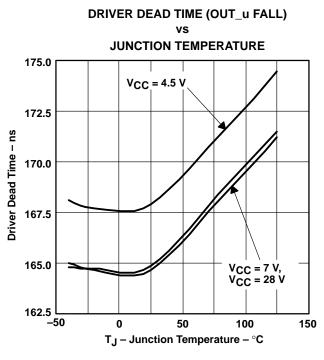
Figure 25











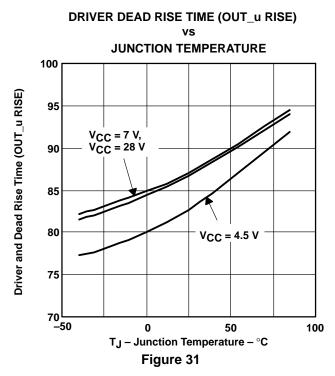


Figure 30

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### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking
	(1)	(2)			(3)	(4)	(5)		(6)
TPS5120DBT	Active	Production	TSSOP (DBT)   30	60   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	PS5120
TPS5120DBT.A	Active	Production	TSSOP (DBT)   30	60   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	PS5120
TPS5120DBTR	Active	Production	TSSOP (DBT)   30	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	PS5120
TPS5120DBTR.A	Active	Production	TSSOP (DBT)   30	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	PS5120
TPS5120DBTRG4	Active	Production	TSSOP (DBT)   30	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	PS5120

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

### PACKAGE OPTION ADDENDUM

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#### OTHER QUALIFIED VERSIONS OF TPS5120:

Automotive: TPS5120-Q1

● Enhanced Product : TPS5120-EP

NOTE: Qualified Version Definitions:

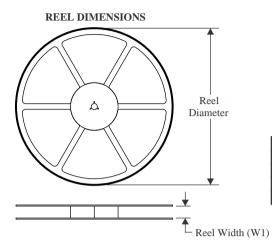
• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

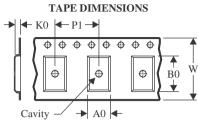
• Enhanced Product - Supports Defense, Aerospace and Medical Applications

### **PACKAGE MATERIALS INFORMATION**

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### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	•	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	` '	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS5120DBTR	TSSOP	DBT	30	2000	330.0	16.4	6.95	8.3	1.6	8.0	16.0	Q1

**PACKAGE MATERIALS INFORMATION** 

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### \*All dimensions are nominal

Device	Package Type	Package Drawing	g Pins SPQ		Length (mm)	Width (mm)	Height (mm)	
TPS5120DBTR	TSSOP	DBT	30	2000	353.0	353.0	32.0	

### **PACKAGE MATERIALS INFORMATION**

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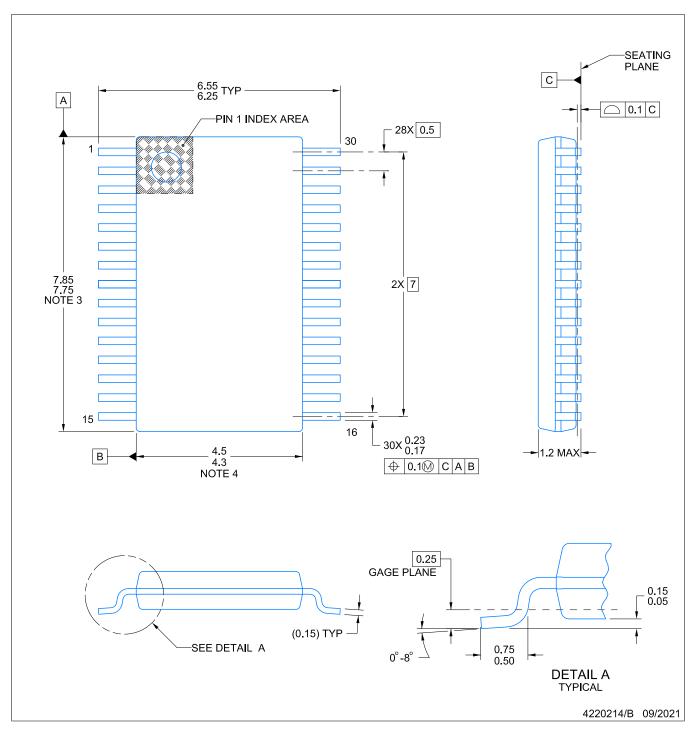
### **TUBE**



### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
TPS5120DBT	DBT	TSSOP	30	60	530	10.2	3600	3.5
TPS5120DBT.A	DBT	TSSOP	30	60	530	10.2	3600	3.5

SMALL OUTLINE PACKAGE



### NOTES:

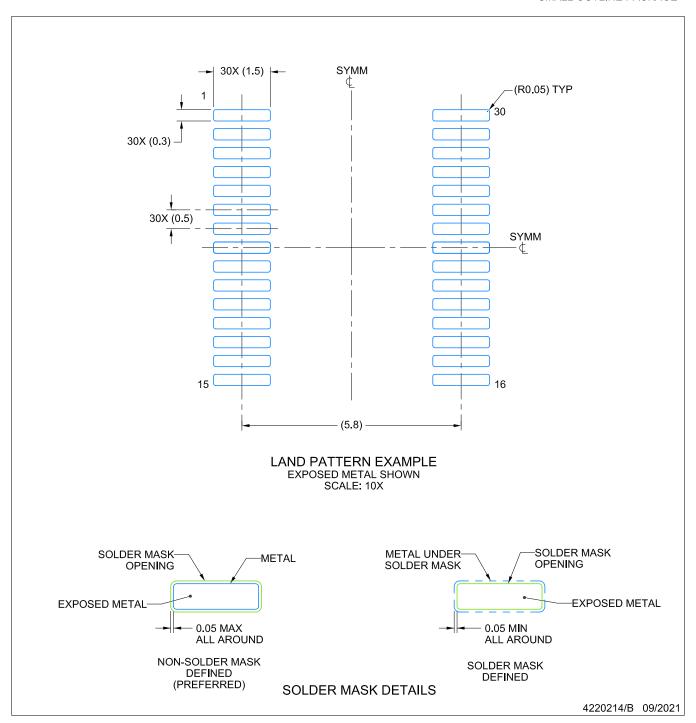
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



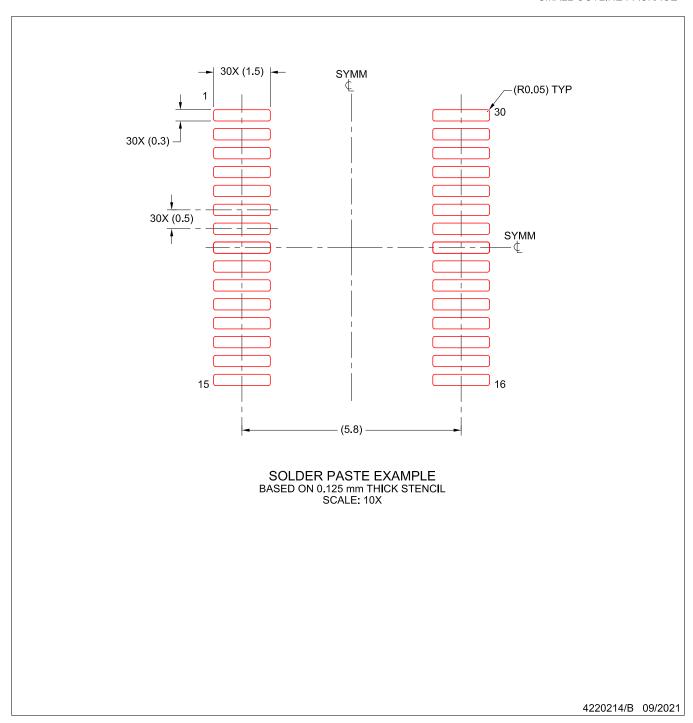
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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